4/9/01

04-26-2001

# 

## RECORDATION FORM COVER SHEET

11-32374 PAT	101688631		
To the Assistant Commissioner for Patents. Please record the attached	original documents or copy thereof.		
1. Name of conveying party(ies):	Name and Address of receiving party(ies):		
Sridhar Ramaswamy 3/14/01	Name: TEXAS INSTRUMENTS INCORPORATED		
Snehamay Sinha 3/13/01 Gopalarao Kadamati 3/16/01	Address: P.O. Box 655474, MS 3999		
Ranjit Gharpurey 3/28/01	City: Dallas		
	State: TX Zip: 75265		
	Additional name(s) & address(es) attached?Yes _X_No		
3. Nature of Conveyance:			
X_ Assignment Merger			
Security AgreementChange of Name			
Other			
Execution Date in order of listed parties: 3/14/01; 3/13/01; 3/16/01; 3/2	8/04		
	6/01		
<ol> <li>Application number(s) or patent number(s).         This document is being filed together with a new application.     </li> </ol>			
Execution date of the application in order of listed parties: :: 3/14/01; 3/1 Title: Semiconductor Device Extractor for Electrostatic Discharge and La Docket No: TI-32374			
A. Patent Application No.(s) S.N. 09/775,320	B. Patent No.(s) X,XXX,XXX		
Additional numbers attached? YesX_ No	Additional numbers attached? YesX_ No		
5. Name and address of party to whom correspondence concerning ocument should be mailed:	6. Number of applications and patents involved:(1)		
Name: Gary C. Honeycutt Texas Instruments Incorporated			
Address: P.O. Box 655474, MS 3999			
City: Dallas			
State: TX Zip: 75265			
	7. Amount of fee enclosed or authorized to be charged: \$40		
•	Deposit Account No: 20-0668 (Attach duplicate copy if paying by deposit account)		
AAHHED1 00000324 200668 09775320 DO NOT	USE THIS SPACE		
40-00 CH			
Statement and signature.			
To the hest of my knowledge and belief, the foregoing information is true	e and correct and any attached copy is a true copy of the original document.		
10 mile 2000 or 10 mile 2000 o	gary C. Honeycutt, Hegy No. 20,250		
1pr 3 01	Gary C. Høneycutt, Reg No. 20,250		
Date /	over Sheet, Attachments and Document: _5_		

TI-32374

#### ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	Semiconductor Device Extractor for Electrostatic Discharge and Latch-Up Applications		
SIGNATURE OF INVENTOR AND NAME	x Ramaswamy	Snehamay Sinha	Sopalarao Kadamati
DATE OF SIGNATURE	× 03/14/01		x / 1/21
RESIDENCE (City, State)	Plano, Texas	Bangalore, India	Plano, Texas
DATE APPLICATION EXECUTED			

After recording Assignment, please return to:

Gary C. Honeycutt

Texas Instruments Incorporated

P.O. Box 655474, MS 3999

Dallas, TX 75265

ATTORNEY	DOCKET	NO.		
TT-32374				

#### **ASSIGNMENT**

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	Semiconductor Device Extractor for Electrostatic Discharge and Latch-Up Applications		
SIGNATURE OF INVENTOR AND NAME	X Planery Ranjit Gharpurey	N/A	N/A
DATE OF SIGNATURE	× 03/28/2001		
RESIDENCE (City, County, State)	Plano, Texas		
DATE APPLICATION EXECUTED			

After recording Assignment, please return to:
Gary C. Honeycutt
Texas Instruments Incorporated
P.O. Box 655474, MS 3999
Dallas, TX 75265

#### ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	Semiconductor Device Extractor for Electrostatic Discharge and Latch-Up Applications		
SIGNATURE OF INVENTOR AND NAME	Sridhar Ramaswamy	X Snehāmay Sinha	Gopalarao Kadamati
DATE OF SIGNATURE		x 13th March 2001	
RESIDENCE (City, State)	Plano, Texas	Bangalore, India	Plano, Texas
DATE APPLICATION EXECUTED			

After recording Assignment, please return to:
Gary C. Honeycutt
Texas Instruments Incorporated
P.O. Box 655474, MS 3999
Dallas, TX 75265

ATTORNEY	DOCKET	NO.	
	T-32374		

### ASSIGNMENT

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	Semiconductor Device Extractor for Electrostatic Discharge and Latch-Up Applications		
SIGNATURE OF INVENTOR AND NAME	Ranjit Gharpurey	N/A	N/A
DATE OF SIGNATURE			
RESIDENCE (City, County, State)	Plano, Texas		
DATE APPLICATION EXECUTED			

After recording Assignment, please return to:
Gary C. Honeycutt
Texas Instruments Incorporated
P.O. Box 655474, MS 3999
Dallas, TX 75265

**RECORDED: 04/09/2001**